## FEATURES

- On-Chip Latches for Both DACs
- +5 V to +15 V Operation
- DACs Matched to $1 \%$
- Four Quadrant Multiplication
- 15 V CMOS Compatible
- See MP7529A or MP7529B for Improved Performance


## APPLICATIONS

- Microprocessor Controlled Gain Circuits
- Microprocessor Controlled Attenuator Circuits
- Microprocessor Controlled Function Generation
- Precision AGC Circuits
- Bus Structured Instruments


## GENERAL DESCRIPTION

The MP7528 is a dual 8-bit digital/analog converter designed using EXAR's proven decoded DAC architecture. It features excellent DAC-to-DAC matching and guaranteed monotonicity.

Separate on-chip latches are provided for each DAC to allow easy microprocessor interface.

Data is transferred into either of the two DAC data latches via a common 8-bit TTL/CMOS compatible input port. Control input
$\overline{D A C A} / D A C B$ determines which DAC is to be loaded. The MP7528's load cycle is similar to the write cycle of a random access memory and the device is bus compatible with most 8-bit microprocessors.

The device operates from $\mathrm{a}+5 \mathrm{~V}$ to +15 V power supply with only 2 mA of current (maximum).

Both DACs offer excellent four quadrant multiplication characteristics with a separate reference input and feedback resistor for each DAC.

## SIMPLIFIED BLOCK AND TIMING DIAGRAM



## ORDERING INFORMATION

| Package <br> Type | Temperature <br> Range | Part No. | INL <br> (LSB) | DNL <br> (LSB) | Gain Error <br> (LSB) |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Plastic Dip | -40 to $+85^{\circ} \mathrm{C}$ | MP7528JN | $\pm 1$ | $\pm 1$ | $\pm 6$ |
| Plastic Dip | -40 to $+85^{\circ} \mathrm{C}$ | MP7528KN | $\pm 1 / 2$ | $\pm 1$ | $\pm 4$ |
| Plastic Dip | -40 to $+85^{\circ} \mathrm{C}$ | MP7528LN | $\pm 1 / 4$ | $\pm 1$ | $\pm 3$ |
| SOIC | -40 to $+85^{\circ} \mathrm{C}$ | MP7528JS | $\pm 1$ | $\pm 1$ | $\pm 6$ |
| SOIC | -40 to $+85^{\circ} \mathrm{C}$ | MP7528KS | $\pm 1 / 2$ | $\pm 1$ | $\pm 4$ |
| SOIC | -40 to $+85^{\circ} \mathrm{C}$ | MP7528LS | $\pm 1 / 4$ | $\pm 1$ | $\pm 3$ |
| PLCC | -40 to $+85^{\circ} \mathrm{C}$ | MP7528JP | $\pm 1$ | $\pm 1$ | $\pm 6$ |
| PLCC | -40 to $+85^{\circ} \mathrm{C}$ | MP7528KP | $\pm 1 / 2$ | $\pm 1$ | $\pm 4$ |
| PLCC | -40 to $+85^{\circ} \mathrm{C}$ | MP7528LP | $\pm 1 / 4$ | $\pm 1$ | $\pm 3$ |
| Ceramic Dip | -40 to $+85^{\circ} \mathrm{C}$ | MP7528AD | $\pm 1$ | $\pm 1$ | $\pm 6$ |
| Ceramic Dip | -40 to $+85^{\circ} \mathrm{C}$ | MP7528BD | $\pm 1 / 2$ | $\pm 1$ | $\pm 4$ |
| Ceramic Dip | -40 to $+85^{\circ} \mathrm{C}$ | MP7528CD | $\pm 1 / 4$ | $\pm 1$ | $\pm 3$ |
| Ceramic Dip | -55 to $+125^{\circ} \mathrm{C}$ | MP7528SD $*$ | $\pm 1$ | $\pm 1$ | $\pm 6$ |
| Ceramic Dip | -55 to $+125^{\circ} \mathrm{C}$ | MP7528TD $*$ | $\pm 1 / 2$ | $\pm 1$ | $\pm 4$ |

*Contact factory for non-compliant military processing

PIN CONFIGURATIONS See Packaging Section for Package Dimensions


20 Pin CDIP, PDIP (0.300") D20, N20


20 Pin SOIC (Jedec, 0.300") S20

## PIN CONFIGURATIONS (CONT'D)



## PIN OUT DEFINITIONS

| PIN NO. | NAME | DESCRIPTION |
| :---: | :---: | :---: |
| 1 | AGND | Analog Ground |
| 2 | Iouta | Current Out DAC A |
| 3 | $\mathrm{R}_{\text {FBA }}$ | Feedback Resistor for DAC A |
| 4 | $V_{\text {REFA }}$ | Reference Input for DAC A |
| 5 | DGND | Digital Ground |
| 6 | $\overline{\mathrm{DACA}} \mathrm{A}$ DAC B | DAC Select |
| 7 | DB7 (MSB) | Data Input Bit 7 |
| 8 | DB6 | Data Input Bit 6 |
| 9 | DB5 | Data Input Bit 5 |
| 10 | DB4 | Data Input Bit 4 |
| 11 | DB3 | Data Input Bit 3 |
| 12 | DB2 | Data Input Bit 2 |
| 13 | DB1 | Data Input Bit 1 |
| 14 | DB0 (LSB) | Data Input Bit 0 |
| 15 | CS | Chip Select |
| 16 | WR | Write |
| 17 | $V_{D D}$ | Power Supply |
| 18 | $V_{\text {REFB }}$ | Reference Input for DAC B |
| 19 | $\mathrm{R}_{\text {FBB }}$ | Feedback Resistor for DAC B |
| 20 | Ioutb | Current Out DAC B |

## ELECTRICAL CHARACTERISTICS

(VDD = + 5 V , VREF = +10 V unless otherwise noted)


ELECTRICAL CHARACTERISTICS (CONT'D)

| Parameter | Symbol | $25^{\circ} \mathrm{C}$ |  |  | Tmin to Tmax Min Max |  | Units | Test Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DIGITAL INPUTS ${ }^{3}$ |  |  |  |  |  |  |  |  |
| Logical "1" Voltage | $\mathrm{V}_{\mathrm{IH}}$ | 2.4 |  |  | 2.4 |  | V |  |
| Logical "0" Voltage | $\mathrm{V}_{\text {IL }}$ |  |  | 0.8 |  | 0.8 | V |  |
| Input Leakage Current | ILKG |  |  | $\pm 1$ |  | $\pm 10$ | $\mu \mathrm{A}$ |  |
| Input Capacitance ${ }^{2}$ |  |  |  |  |  |  |  |  |
| Data | $\mathrm{Cln}_{\text {IN }}$ |  |  | 10 |  | 10 | pF |  |
| Control | $\mathrm{Cin}_{\text {I }}$ |  |  | 15 |  | 15 | pF |  |
| ANALOG OUTPUTS ${ }^{2}$ |  |  |  |  |  |  |  |  |
| Output Capacitance |  |  |  |  |  |  |  |  |
|  | Couta |  |  | 120 |  | 120 | pF | DAC Inputs all 1's |
|  | Couta |  |  | 50 |  | 50 | pF | DAC Inputs all 0's |
|  | Coutb |  |  | 120 |  | 120 | pF | DAC Inputs all 1's |
|  | Coutb |  |  | 50 |  | 50 | pF | DAC Inputs all 0's |
| POWER SUPPLY ${ }^{5}$ |  |  |  |  |  |  |  |  |
| Functional Voltage Range ${ }^{2}$ | $V_{\text {DD }}$ | 4.5 |  | 15.75 | 4.5 | 15.75 | V |  |
| Supply Current | IDD |  |  |  |  | 2 | mA | All digital inputs $=0 \mathrm{~V}$ or all $=5 \mathrm{~V}$ |
|  |  |  |  |  |  | 2 | mA | All digital inputs $=\mathrm{V}_{\mathrm{IL}}$ or all $=\mathrm{V}_{\mathrm{IH}}$ |
| SWITCHING |  |  |  |  |  |  |  |  |
| CHARACTERISTICS ${ }^{4}$ |  |  |  |  |  |  |  |  |
| Chip Select to Write Set-Up Time | $\mathrm{t}_{\mathrm{CS}}$ | 200 |  |  | 230 |  | ns |  |
| Chip Select to Write Hold Time | $\mathrm{t}_{\mathrm{CH}}$ | 20 |  |  | 30 |  | ns |  |
| DAC Select to Write Set-Up Time | $\mathrm{t}_{\mathrm{AS}}$ | 200 |  |  | 230 |  | ns |  |
| DAC Select to Write Hold Time | $\mathrm{t}_{\mathrm{AH}}$ | 20 |  |  | 30 |  |  |  |
| Data Valid to Write Set-Up Time | $t_{\text {dS }}$ | 110 |  |  | 130 |  | ns |  |
| Data Valid to Write Hold Time | $\mathrm{t}_{\mathrm{DH}}$ | 0 |  |  | 0 |  | ns |  |
| Write Pulse Width | twr | 180 |  |  | 200 |  | ns |  |

## NOTES:

Full Scale Range (FSR) is 10 V for unipolar mode.
Guaranteed but not production tested.
Digital input levels should not go below ground or exceed the positive supply voltage, otherwise damage may occur. See timing diagram.
Specified values guarantee functionality. Refer to other parameters for accuracy.

Specifications are subject to change without notice

## ELECTRICAL CHARACTERISTICS

( $\mathrm{V}_{\mathrm{DD}}=+15 \mathrm{~V}, \mathrm{~V}_{\mathrm{REF}}=+10 \mathrm{~V}$ unless otherwise noted)


Rev. 2.00

## ELECTRICAL CHARACTERISTICS (CONT'D)



## NOTES:

Full Scale Range (FSR) is 10 V for unipolar mode.
Guaranteed but not production tested.
Digital input levels should not go below ground or exceed the positive supply voltage, otherwise damage may occur. See timing diagram.
Specified values guarantee functionality. Refer to other parameters for accuracy.

Specifications are subject to change without notice

ABSOLUTE MAXIMUM RATINGS (TA = +25 ${ }^{\circ} \mathrm{C}$ unless otherwise noted) ${ }^{\mathbf{1}} \mathbf{\text { , }} \mathbf{2 , 3}$

| $V_{D D}$ to GND | 17 V |
| :---: | :---: |
| AGND to DGND . . (Functionality Guaranteed $\pm 0.5 \mathrm{~V}$ ) | $\pm 1 \mathrm{~V}$ |
| Digital Input Voltage to DGND | $-0.5 \mathrm{~V},+17 \mathrm{~V}$ |
| $\mathrm{V}_{\text {PIN2 }}$, $\mathrm{V}_{\text {PIN20 }}$ to GND | -0.5 V, +17 V |
| $\mathrm{V}_{\text {REFA }}, \mathrm{V}_{\text {REFB }}$ to GND | $\pm 25$ |

$V_{\text {RFBA }}$, V $_{\text {RFBB }}$ to GND . . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm 25 \mathrm{~V}$
Storage Temperature . .................... $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature (Soldering, 10 secs.) .......... $+300^{\circ} \mathrm{C}$
Package Power Dissipation Rating to $75^{\circ} \mathrm{C}$ CDIP, PDIP, SOIC, PLCC . ..................... 900 mW Derates above $75^{\circ} \mathrm{C}$. . . . . . . . . . . . . . . . . . . . . . $12 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$

## NOTES:

1 Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation at or above this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.
2 Any input pin which can see a value outside the absolute maximum ratings should be protected by Schottky diode clamps (HP5082-2835) from input pin to the supplies.
GND refers to AGND and DGND.

## Rev. 2.00

## INTERFACE LOGIC INFORMATION

DAC Selection: Both DAC latches share a common 8-bit input port. The control input DACA/DACB selects which DAC can accept data from the input port.

Mode Selection: Inputs $\overline{C S}$ and WR control the operating mode of the selected DAC. See Mode Selection Table below:

Write Mode: When CS and WR are both low the selected DAC is in the write mode. The input data latches of the selected DAC are transparent and its analog output responds to activity on DB0-DB7.

Hold Mode: The selected DAC latch retains the data which was present on DB0-DB7 just prior to $\overline{C S}$ and $\overline{W R}$ assuming a high state. Both analog outputs remain at the values corresponding to the data in their respective latches.

| DAC A/DAC B | CS | WR | DAC A | DAC B |
| :---: | :---: | :---: | :---: | :---: |
| L | L | L | Write | Hold |
| H | L | L | Hold | Write |
| X | H | X | Hold | Hold |
| X | X | H | Hold | Hold |

$\mathrm{L}=\mathrm{LOW}$ state, $\mathrm{H}=\mathrm{HIGH}$ state, $\mathrm{X}=$ Don't care state

Table 1. Mode Selection Table


Figure 1. Write Cycle Timing Diagram

MICROPROCESSOR INTERFACE


Analog circuitry has been omitted for clarity
*A = Decoded 7528 DAC A Address
**A + 1 = Decoded 7528 DAC B Address

Figure 2. MP7528 Dual DAC to 6800 CPU Interface


Analog circuitry has been omitted for clarity
*A = Decoded 7528 DAC A Address
**A + 1 = Decoded 7528 DAC B Address

## NOTE:

8085 instruction SHLD (store H \& L direct) can update both DACS with data from $H$ and $L$ registers
Figure 3. MP7528 Dual DAC to 8085
CPU Interface

## PERFORMANCE CHARACTERISTICS



Graph 1. Relative Accuracy vs. Digital Code 5 V

$-\mathrm{DACA}-\mathrm{DACB}$

Graph 2. Relative Accuracy vs. Digital Code 15 V

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## 20 LEAD CERAMIC DUAL-IN-LINE (300 MIL CDIP) D20



| SYMBOL | INCHES |  | MILLIMETERS |  | NOTES |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | MIN | MAX | MIN | MAX |  |
| A | - | 0.200 | - | 5.08 | - |
| b | 0.014 | 0.023 | 0.356 | 0.584 | - |
| $\mathrm{b}_{1}$ | 0.038 | 0.065 | 0.965 | 1.65 | 2 |
| c | 0.008 | 0.015 | 0.203 | 0.381 | - |
| D | - | 1.060 | - | 26.92 | 4 |
| E | 0.220 | 0.310 | 5.59 | 7.87 | 4 |
| $\mathrm{E}_{1}$ | 0.290 | 0.320 | 7.37 | 8.13 | 7 |
| e | 0.100 BSC |  | 2.54 BSC |  | 5 |
| L | 0.125 | 0.200 | 3.18 | 5.08 | - |
| $\mathrm{L}_{1}$ | 0.150 | - | 3.81 | - | - |
| Q | 0.015 | 0.070 | 0.381 | 1.78 | 3 |
| S | - | 0.080 | - | 2.03 | 6 |
| $\mathrm{S}_{1}$ | 0.005 | - | 0.13 | - | 6 |
| $\alpha$ | $0^{\circ}$ | $15^{\circ}$ | $0^{\circ}$ | $15^{\circ}$ | - |

## NOTES

1. Index area; a notch or a lead one identification mark is located adjacent to lead one and is within the shaded area shown.
2. The minimum limit for dimension $b_{1}$ may be 0.023 ( 0.58 mm ) for all four corner leads only.
3. Dimension $Q$ shall be measured from the seating plane to the base plane.
4. This dimension allows for off-center lid, meniscus and glass overrun.
5. The basic lead spacing is 0.100 inch ( 2.54 mm ) between centerlines.
6. Applies to all four corners.
7. This is measured to outside of lead, not center.

## 20 LEAD PLASTIC DUAL-IN-LINE (300 MIL PDIP) <br> N20



| SYMBOL | INCHES |  | MILLIMETERS |  |
| :---: | :---: | :---: | :---: | :---: |
|  | MIN | MAX | MIN | MAX |
| A | - | 0.200 | - | 5.08 |
| $\mathrm{A}_{1}$ | 0.015 | - | 0.38 | - |
| B | 0.014 | 0.023 | 0.356 | 0.584 |
| $\mathrm{B}_{1}(1)$ | 0.038 | 0.065 | 0.965 | 1.65 |
| C | 0.008 | 0.015 | 0.203 | 0.381 |
| D | 0.945 | 1.060 | 24.0 | 26.92 |
| E | 0.295 | 0.325 | 7.49 | 8.26 |
| $\mathrm{E}_{1}$ | 0.220 | 0.310 | 5.59 | 7.87 |
| e |  | BSC |  | BSC |
| L | 0.115 | 0.150 | 2.92 | 3.81 |
| $\alpha$ | $0^{\circ}$ | $15^{\circ}$ | $0^{\circ}$ | $15^{\circ}$ |
| $Q_{1}$ | 0.055 | 0.070 | 1.40 | 1.78 |
| S | 0.040 | 0.080 | 1.02 | 2.03 |

Note: (1) The minimum limit for dimensions B1 may be 0.023 " ( 0.58 mm ) for all four corner leads only.

## 20 LEAD SMALL OUTLINE (300 MIL JEDEC SOIC) S20



|  | INCHES |  | MILLIMETERS |  |
| :---: | ---: | ---: | ---: | ---: |
| SYMBOL | MIN | MAX | MIN | MAX |
| A | 0.097 | 0.104 | 2.464 | 2.642 |
| $\mathrm{~A}_{1}$ | 0.0050 | 0.0115 | 0.127 | 0.292 |
| B | 0.014 | 0.019 | 0.356 | 0.483 |
| C | 0.0091 | 0.0125 | 0.231 | 0.318 |
| D | 0.500 | 0.510 | 12.70 | 12.95 |
| E | 0.292 | 0.299 | 7.42 | 7.59 |
| e | 0.050 BSC |  | 1.27 |  |
| BSC |  |  |  |  |
| H | 0.400 | 0.410 | 10.16 | 10.41 |
| h | 0.010 | 0.016 | 0.254 | 0.406 |
| L | 0.016 | 0.035 | 0.406 | 0.889 |
| $\alpha$ | $0^{\circ}$ | $8^{\circ}$ | $0^{\circ}$ | $8^{\circ}$ |

Notes

Notes

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